

# SN54ABT16601, SN74ABT16601 18-BIT UNIVERSAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS210B – JUNE 1992 – REVISED JULY 1994

- Members of the Texas Instruments *Widebus™* Family
- State-of-the-Art *EPIC-II B™* BiCMOS Design Significantly Reduces Power Dissipation
- *UBT™* (Universal Bus Transceiver) Combines D-Type Latches and D-Type Flip-Flops for Operation in Transparent, Latched, Clocked, or Clock-Enabled Mode
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical  $V_{OLP}$  (Output Ground Bounce)  $< 0.8\text{ V}$  at  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$
- Flow-Through Architecture Optimizes PCB Layout
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

## description

These 18-bit universal bus transceivers combine D-type latches and D-type flip-flops to allow data flow in transparent, latched, and clocked modes.

Data flow in each direction is controlled by output-enable ( $\overline{OEAB}$  and  $\overline{OEBA}$ ), latch-enable ( $\overline{LEAB}$  and  $\overline{LEBA}$ ), and clock ( $\overline{CLKAB}$  and  $\overline{CLKBA}$ ) inputs. The clock can be controlled by the clock-enable ( $\overline{CLKENAB}$  and  $\overline{CLKENBA}$ ) inputs. For A-to-B data flow, the device operates in the transparent mode when  $\overline{LEAB}$  is high. When  $\overline{LEAB}$  is low, the A data is latched if  $\overline{CLKAB}$  is held at a high or low logic level. If  $\overline{LEAB}$  is low, the A-bus data is stored in the latch/flip-flop on the low-to-high transition of  $\overline{CLKAB}$ . Output enable  $\overline{OEAB}$  is active low. When  $\overline{OEAB}$  is low, the outputs are active. When  $\overline{OEAB}$  is high, the outputs are in the high-impedance state.

Data flow for B to A is similar to that of A to B but uses  $\overline{OEBA}$ ,  $\overline{LEBA}$ ,  $\overline{CLKBA}$ , and  $\overline{CLKENBA}$ .

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74ABT16601 is available in TI's shrink small-outline package (DL), which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The SN54ABT16601 is characterized over the full military temperature range of  $-55^\circ\text{C}$  to  $125^\circ\text{C}$ . The SN74ABT16601 is characterized for operation from  $-40^\circ\text{C}$  to  $85^\circ\text{C}$ .

SN54ABT16601 . . . WD PACKAGE  
SN74ABT16601 . . . DGG OR DL PACKAGE  
(TOP VIEW)

$\overline{OEAB}$	1	56	$\overline{CLKENAB}$
$\overline{LEAB}$	2	55	$\overline{CLKAB}$
A1	3	54	B1
GND	4	53	GND
A2	5	52	B2
A3	6	51	B3
$V_{CC}$	7	50	$V_{CC}$
A4	8	49	B4
A5	9	48	B5
A6	10	47	B6
GND	11	46	GND
A7	12	45	B7
A8	13	44	B8
A9	14	43	B9
A10	15	42	B10
A11	16	41	B11
A12	17	40	B12
GND	18	39	GND
A13	19	38	B13
A14	20	37	B14
A15	21	36	B15
$V_{CC}$	22	35	$V_{CC}$
A16	23	34	B16
A17	24	33	B17
GND	25	32	GND
A18	26	31	B18
$\overline{OEBA}$	27	30	$\overline{CLKBA}$
$\overline{LEBA}$	28	29	$\overline{CLKENBA}$

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# SN54ABT16601, SN74ABT16601

## 18-BIT UNIVERSAL BUS TRANSCEIVERS

### WITH 3-STATE OUTPUTS

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FUNCTION TABLE†

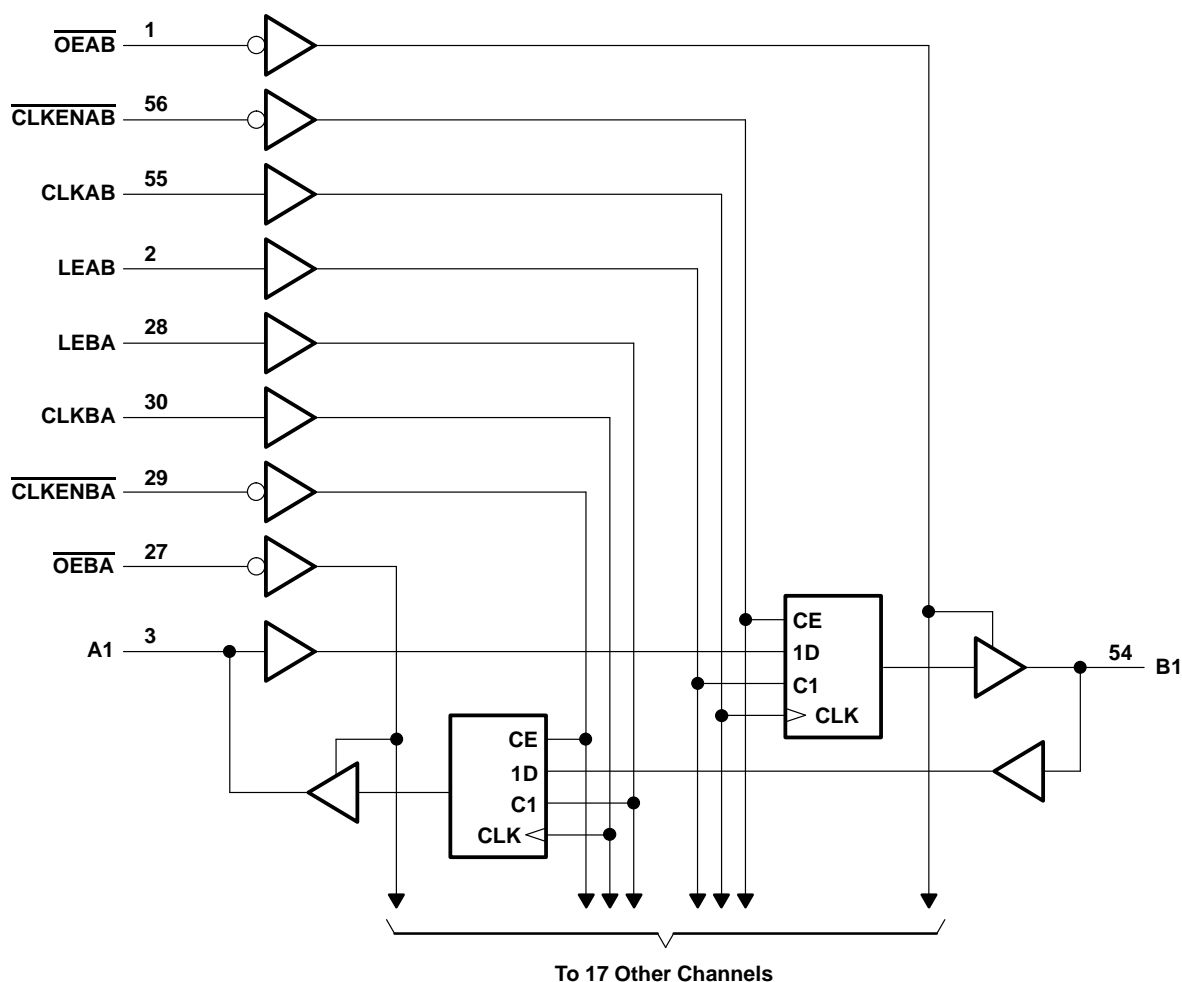
INPUTS					OUTPUT B
CLKENAB	OEAB	LEAB	CLKAB	A	
X	H	X	X	X	Z
X	L	H	X	L	L
X	L	H	X	H	H
H	L	L	X	X	B <sub>0</sub> ‡
H	L	L	X	X	B <sub>0</sub> ‡
L	L	L	↑	L	L
L	L	L	↑	H	H
L	L	L	L	X	B <sub>0</sub> ‡
L	L	L	H	X	B <sub>0</sub> §

† A-to-B data flow is shown: B-to-A flow is similar but uses OEBA, LEBA, CLKBA, and CLKENBA.

‡ Output level before the indicated steady-state input conditions were established.

§ Output level before the indicated steady-state input conditions were established, provided that CLKAB was low before LEAB went low.

### logic diagram (positive logic)



# SN54ABT16601, SN74ABT16601

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SCBS210B – JUNE 1992 – REVISED JULY 1994

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, $V_{CC}$	–0.5 V to 7 V
Input voltage range, $V_I$ (except I/O ports) (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the high state or power-off state, $V_O$	–0.5 V to 5.5 V
Current into any output in the low state, $I_O$ : SN54ABT16601	96 mA
SN74ABT16601	128 mA
Input clamp current, $I_{IK}$ ( $V_I < 0$ )	–18 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ )	–50 mA
Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air) (see Note 2): DGG package	1 W
DL package	1.4 W
Storage temperature range	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.  
 2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.  
 For more information, refer to the *Package Thermal Considerations* application note in the 1994 *ABT Advanced BiCMOS Technology Data Book*, literature number SCBD002B.

#### recommended operating conditions (see Note 3)

		SN54ABT16601		SN74ABT16601		UNIT
		MIN	MAX	MIN	MAX	
$V_{CC}$	Supply voltage	4.5	5.5	4.5	5.5	V
$V_{IH}$	High-level input voltage	2		2		V
$V_{IL}$	Low-level input voltage		0.8		0.8	V
$V_I$	Input voltage	0	$V_{CC}$	0	$V_{CC}$	V
$I_{OH}$	High-level output current		–24		–32	mA
$I_{OL}$	Low-level output current		48		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled			10	ns/V
$T_A$	Operating free-air temperature	–55	125	–40	85	°C

NOTE 3: Unused or floating pins (input or I/O) must be held high or low.



# SN54ABT16601, SN74ABT16601

## 18-BIT UNIVERSAL BUS TRANSCEIVERS

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SCBS210B – JUNE 1992 – REVISED JULY 1994

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER		TEST CONDITIONS	T <sub>A</sub> = 25°C			SN54ABT16601		SN74ABT16601		UNIT	
			MIN	TYP†	MAX	MIN	MAX	MIN	MAX		
V <sub>IK</sub>		V <sub>CC</sub> = 4.5 V, I <sub>I</sub> = –18 mA	–1.2			–1.2		–1.2		V	
V <sub>OH</sub>		V <sub>CC</sub> = 4.5 V, I <sub>OH</sub> = –3 mA	2.5			2.5		2.5		V	
		V <sub>CC</sub> = 5 V, I <sub>OH</sub> = –3 mA	3			3		3			
		V <sub>CC</sub> = 4.5 V	I <sub>OH</sub> = –24 mA	2			2				
			I <sub>OH</sub> = –32 mA	2*					2		
V <sub>OL</sub>		V <sub>CC</sub> = 4.5 V	I <sub>OL</sub> = 48 mA	0.55			0.55		V		
			I <sub>OL</sub> = 64 mA	0.55*			0.55				
I <sub>I</sub>	Control inputs	V <sub>CC</sub> = 5.5 V, V <sub>I</sub> = V <sub>CC</sub> or GND	±1			±1		±1		μA	
	A or B ports		±20			±100		±20			
I <sub>off</sub>		V <sub>CC</sub> = 0, V <sub>I</sub> or V <sub>O</sub> ≤ 4.5 V	±100					±100		μA	
I <sub>CEX</sub>	Outputs high	V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 5.5 V	50			50		50		μA	
I <sub>O</sub> ‡		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 2.5 V	–50	–100	–180	–50	–180	–50	–180	mA	
I <sub>OZH</sub> §		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 2.7 V	10			10		10		μA	
I <sub>OZL</sub> §		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 0.5 V	–10			–10		–10		μA	
I <sub>CC</sub>	A or B ports	V <sub>CC</sub> = 5.5 V, I <sub>O</sub> = 0, V <sub>I</sub> = V <sub>CC</sub> or GND	Outputs high		1.9	3	2		3		mA
			Outputs low		28	36	35		36		
			Outputs disabled		1.6	3	2		3		
ΔI <sub>CC</sub> ¶		V <sub>CC</sub> = 5.5 V, One input at 3.4 V, Other inputs at V <sub>CC</sub> or GND	50					50		μA	
						1.5				mA	
C <sub>i</sub>	Control inputs	V <sub>I</sub> = 2.5 V or 0.5 V	3							pF	
C <sub>io</sub>	A or B ports	V <sub>O</sub> = 2.5 V or 0.5 V	9							pF	

\* On products compliant to MIL-STD-883, Class B, this parameter does not apply.

† All typical values are at V<sub>CC</sub> = 5 V.

‡ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

§ The parameters I<sub>OZH</sub> and I<sub>OZL</sub> include the input leakage current.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.

**timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)**

			SN54ABT16601		SN74ABT16601		UNIT
			MIN	MAX	MIN	MAX	
f <sub>clock</sub>	Clock frequency		0	150	0	150	MHz
t <sub>w</sub>	Pulse duration	LEAB or LEBA high	2.5		2.5		ns
		CLKAB or CLKBA high or low	3		3		
t <sub>su</sub>	Setup time	A before CLKAB↑ or B before CLKBA↑	4.6		4		ns
		A before LEAB↓ or B before LEBA↓	2.5	CLK high	2.5		
				CLK low		1	
		CLKEN before CLK↑	2.9		2.5		
t <sub>h</sub>	Hold time	A after CLKAB↑ or B after CLKBA↑	0.4		0		ns
		A after LEAB↓ or B after LEBA↓	2.8		2		
		CLKEN after CLK↑	0		0		



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SCBS210B – JUNE 1992 – REVISED JULY 1994

switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $C_L = 50$  pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$			SN54ABT16601		SN74ABT16601		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
$f_{\max}$			150	200		150		150		MHz
$t_{PLH}$	A or B	B or A	1.5	2.5	3.6	1	4.6	1.5	4	ns
$t_{PHL}$			1.5	3.4	4.7	1	5.1	1.5	4.9	
$t_{PLH}$	LEAB or LEBA	B or A	2	3.4	4.7	1	5.6	2	5	ns
$t_{PHL}$			2	3.7	5	1	5.5	2	5.2	
$t_{PLH}$	CLKAB or CLKBA	B or A	1.5	3.2	4.5	1	5.2	1.5	4.7	ns
$t_{PHL}$			1.5	3.2	4.4	1	5	1.5	4.6	
$t_{PZH}$	$\overline{OEAB}$ or $\overline{OEBA}$	B or A	2	4	5	1	5.7	2	5.5	ns
$t_{PZL}$			2	4.2	5.6	1	6	2	5.8	
$t_{PHZ}$	$\overline{OEAB}$ or $\overline{OEBA}$	B or A	2	4.5	5.4	1	6.8	2	6.2	ns
$t_{PLZ}$			1.5	3.4	4.7	1	6.3	1.5	5.4	

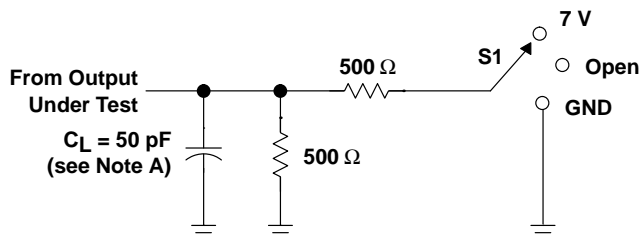
# SN54ABT16601, SN74ABT16601

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### WITH 3-STATE OUTPUTS

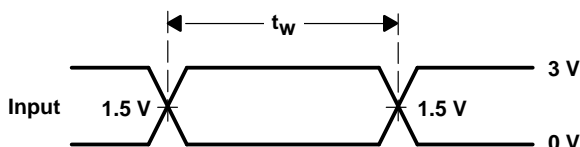
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#### PARAMETER MEASUREMENT INFORMATION

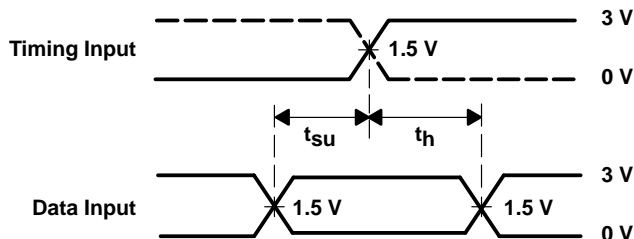


LOAD CIRCUIT FOR OUTPUTS

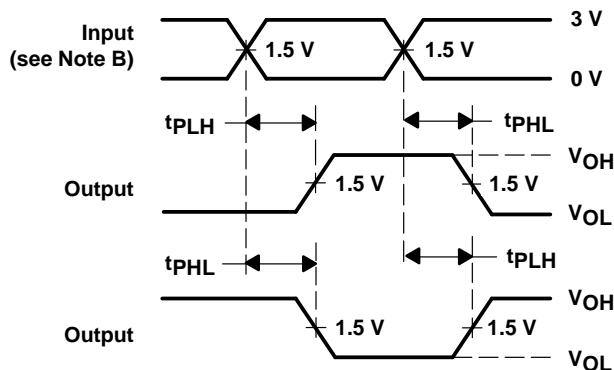
TEST	S1
$t_{PLH}/t_{PHL}$	Open
$t_{PLZ}/t_{PZL}$	7 V
$t_{PHZ}/t_{PZH}$	Open



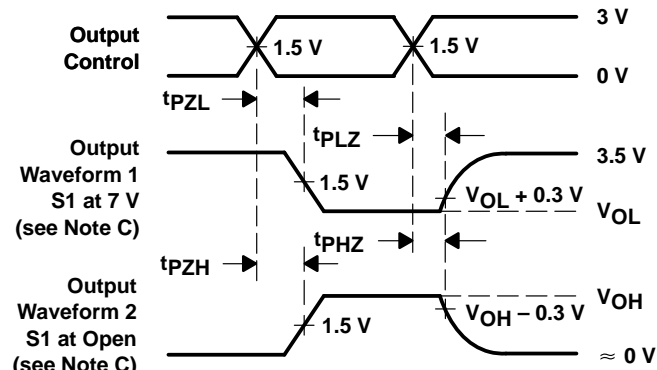
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES: A.  $C_L$  includes probe and jig capacitance.
- B. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .
- C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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